Overview

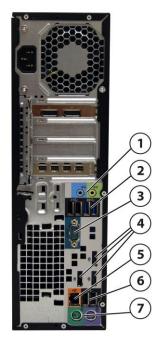
#### **HP Z230 SFF Workstation**



- 1. External 5.25" bay
- 2. External/internal shared 3.5" bay
- 3. Power button
- 4. Front I/O (top to bottom order): 2 USB 2.0 ports, 2 USB 3.0 ports, Microphone/Headphone, Headphone
- 5. Optional SFF tower stand



#### Overview



- 1. 1 Audio Line In, 1 Audio Line Out
- 2. 2 USB 3.0, 2 USB 2.0
- 3. 1 serial port
- 4. 3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only)
- 5. RJ-45 to integrated GBE
- 6. 2 USB 2.0
- 7. PS/2 ports (keyboard, mouse)

Form Factor	Small Form Factor
Operating Systems	Preinstalled:
	Windows 7 Professional 32/64
	Windows 8.1 Pro 64-bit
	<ul> <li>Windows 8.1 Pro 64 Downgrade to Windows 7 Professional 32/64</li> </ul>
	Windows 8.1 64-bit
	Windows 8.1 Simplified Chinese Edition 64-bit
	Windows 8.1 Single Language (EM)
	Ubuntu Linux 14.04
	• HP Installer Kit for Linux [includes drivers for 64-bit OS versions of Red Hat Enterprise Linux 6 and SUSE Linux Enterprise Desktop (SLED) 11]
	SUSE Linux Enterprise Desktop 11 64-bit (90 day license)
	• Red Hat Enterprise Linux Workstation (1 year paper license available; Preinstall not available)
	Supported
	Supported:



#### Overview

	Note	• Windo	ws 7 Enterpris ws 8/8.1 Enter ailed OS/hardw	prise 64 are supp	ort inform		ux, see:		
Name	Cores	Clock Speed (GHz)	.com/support/ Intel® Turbo Boost Technology <sup>1</sup>	Cache (MB)	Memory Speed (MHz)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro™ Technology	TDP (W)
Intel® Xeon® processor E3-1281v3	4	3.7	4.1	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1280v3	4	3.6	4.0	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1271v3	4	3.6	4.0	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1246v3	4	3.5	3.9	8	1600	Y	Intel HD Graphics P4600	Y	84W
Intel® Xeon® processor E3-1245v3	4	3.4	3.8	8	1600	Y	Intel HD Graphics P4600	Y	84W
Intel® Xeon® processor E3-1241v3	4	3.5	3.9	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1240v3	4	3.4	3.8	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1231v3	4	3.4	3.8	8	1600	Y	N/A	Y	80W
Intel® Xeon® processor E3-1226v3	4	3.3	3.7	8	1600	N	Intel HD Graphics P4600	Y	84W
Intel® Xeon® processor E3-1225v3	4	3.2	3.6	8	1600	N	Intel HD Graphics P4600	Y	84W
Intel® Core™ i7-4790 processor	4	3.6	4.0	8	1600	Y	Intel HD Graphics 4600	Y	84W
Intel® Core™ i5-4690 processor	4	3.5	3.9	6	1600	N	Intel HD Graphics 4600	Y	84W
Intel® Core™ i5-4590 processor	4	3.3	3.7	6	1600	N	Intel HD Graphics 4600	Y	84W
Intel® Core™ i3-4350 processor	2	3.6	NA	4	1600	Y	Intel HD Graphics 4600	N	54W
Intel® Core™ i3-4160 processor	2	3.6	NA	3	1600	Y	Intel HD Graphics 4400	N	54W
Intel® Core™ i3-4150 processor	2	3.5	NA	3	1600	Y	Intel HD Graphics 4400	N	54W
Intel® Pentium® G3240 processor	2	3.1	NA	3	1333	N	Intel HD Graphics	N	54W

<sup>1</sup>The specifications shown in this column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

Available Processor Disclaimers Integrated Intel® HD graphics is not supported on the Intel® Xeon Processor E3-1230v3, E3-1240v3, E3-1270v3 or E3-1280v3.



#### **Overview**

	Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.
	Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: <a href="http://www.intel.com/products/processor_number/">http://www.intel.com/products/processor_number/</a> for details.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: <u>http://www.intel.com/info/em64t</u> for more information.
	Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
Color	Jack Black
Convertibility	The Z230 SFF can either be placed flat on the desktop or made to stand on the desk with the optional tower stand.
Expansion Slots (see system board section for more details)	
inore decails)	<ul> <li>1 PCIe Gen2 x1 slot/x4 connector</li> <li>1 PCIe Gen2 x1 slot</li> </ul>
	(all slots are Low Profile)
	<b>Note:</b> In the PCIe Gen3 x16 slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.
Expansion Bays (see	1 external Half Height 5.25" bay
storage section for more details)	1 shared internal/external 3.5" bay
uetaits)	<ul> <li>1 internal 3.5" bay</li> <li>1 internal 2.5" bay (for SSD only)</li> </ul>
Front I/O	2 USB 3.0, 2 USB 2.0, 1 Headphone, and 1 Microphone
Internal I/O	
internati/O	1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.
Rear I/O	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45</li> </ul>
Rear I/O	<ol> <li>USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> </ol>
Rear I/O Interfaces Supported	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> <li>14-in-1 Media Card Reader (optional)</li> </ul>
Rear I/O	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> <li>14-in-1 Media Card Reader (optional)</li> <li>Standard desktop orientation: 100 x 337 x 384 mm (3.95 x 13.3 x 15.1 in); Optional SFF Tower</li> </ul>
Rear I/O Interfaces Supported Chassis Dimensions	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> <li>14-in-1 Media Card Reader (optional)</li> <li>Standard desktop orientation: 100 x 337 x 384 mm (3.95 x 13.3 x 15.1 in); Optional SFF Tower orientation (excluding stand dimension): 337 x 100 x 384 mm (13.3 x 3.95 x 15.1 in)</li> <li>Exact weights depend upon configuration; Typical Weight* 7.2 kg (15.87 lbs)</li> </ul>
Rear I/O Interfaces Supported Chassis Dimensions (H x W x D)	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> <li>14-in-1 Media Card Reader (optional)</li> <li>Standard desktop orientation: 100 x 337 x 384 mm (3.95 x 13.3 x 15.1 in); Optional SFF Tower orientation (excluding stand dimension): 337 x 100 x 384 mm (13.3 x 3.95 x 15.1 in)</li> <li>Exact weights depend upon configuration;</li> </ul>
Rear I/O Interfaces Supported Chassis Dimensions (H x W x D)	<ul> <li>1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10(3.0 x1, 2.0 x1) and 2x5(2.0 x2) header: supports one HP Internal USB 2.0 Port Kit and one USB 3.0 Media Card Reader.</li> <li>3 DisplayPort (DP 1.2) outputs from Intel HD graphics (available on specific processors only); 2 USB 3.0 ports, 4 USB 2.0 ports, 2 serial ports (1 standard, 1 optional), 1 parallel port (optional), 2 PS/2, RJ-45 (LoM), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports (optional).</li> <li>14-in-1 Media Card Reader (optional)</li> <li>Standard desktop orientation: 100 x 337 x 384 mm (3.95 x 13.3 x 15.1 in); Optional SFF Tower orientation (excluding stand dimension): 337 x 100 x 384 mm (13.3 x 3.95 x 15.1 in)</li> <li>Exact weights depend upon configuration; Typical Weight* 7.2 kg (15.87 lbs)</li> <li>Shipping Weight* 9.8 kg (21.6 lbs)</li> </ul>



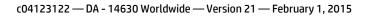
#### **Overview**

	Non-operating: -40° to 60°C ( -40° to 140°F)
	<b>Notes:</b> Derate the maximum operating temperature by one degree C (1.8 degrees F) for every 305m (1,000 ft) altitude over 1,524m (5,000 ft).
Humidity	Operating: 8% to 85% Non-operating: 8% to 90%
Maximum Altitude (non-pressurized)	Operating: 3,000 m; 10,000 ft Non-operating: 9,100 m; 30,000 ft
Power Supply	240W 92% Efficiency wide-ranging, active Power Factor Correction (PFC)
	240W Standard Efficiency wide-ranging, active PFC Power Supply option available in some countries. The Power Supply Efficiency Report for the 240W, 92% efficiency power supply may be found at these links:
	http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_PS-4241- 1HA_240W_ECOS%203449_Report.pdf
	http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD_D12- 240P2A_240W_ECOS%203384_Report.pdf
	http://www.plugloadsolutions.com/psu_reports/Hewlett-Packard%20Company_DPS-240AB- 3%20A_240W_ECOS%203416_Report.pdf
	http://www.plugloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_PCC002- 020H2_240W_EC0S%203440_Report.pdf
Backup Devices	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit <a href="http://www.hp.com/go/connect">http://www.hp.com/go/connect</a>
Chipset	Intel® C226 chipset
Memory	4 DIMM slots, supporting up to 32GB ECC/non-ECC, DDR3 1600 MHz
Memory disclaimers	The CPUs determine the speed at which the memory is clocked. If a 1333 MHz capable CPU is used in the system, the maximum speed the memory will run at is 1333 MHz regardless of the specified speed of the memory.
Workstation ISV Certifications	See the latest list of certifications at <a href="http://www.hp.com/united-states/campaigns/workstations/partnerships.html">http://www.hp.com/united-states/campaigns/workstations/partnerships.html</a>



#### **Supported Components**

Processors		Factory Configured	Option Kit	Support Notes
	Intel® Xeon® processor E3-1200 v3 family (Z230)			
	Intel® Xeon® processor E3-1281v3, Quad-Core, 8 MB cache, 3.7 GHz, up to 4.1 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1280v3, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1271v3, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1246v3, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1245v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1241v3, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1240v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1231v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1226v3, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	Intel® Xeon® processor E3-1225v3, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 2
	4th generation Intel® Core™ processor family			
	Intel® Core™ i7-4790 processor, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 3
	Intel® Core™ i5-4690 processor, Quad-Core, 6 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 3
	Intel® Core™ i5-4590 processor, Quad-Core, 6 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology	Y	Ν	See Note 3
	Intel® Core™ i3-4350 processor, Dual-Core, 4 MB cache, 3.6 GHz	Y	Ν	See Note 2
	Intel® Core™ i3-4160 processor, Dual-Core, 3 MB cache, 3.6 GHz	Y	Y	
	Intel® Core™ i3-4150 processor, Dual-Core, 3 MB cache, 3.5 GHz	Y	Ν	See Note 2
	Intel® Core™ i3-4130 processor, Dual-Core, 4 MB cache, 3.4 GHz	Y	Ν	See Note 2
	Dual Core Intel® Pentium® Processors (Z230)			





#### **Supported Components**

Intel® Pentium® G3240 processor, Dual-Core, 3 MB cache, 3.1 GHz	Y	Ν	See Note 2
<b>NOTE 1:</b> Intel HD Graphics P4600 supports workstation-speci compatibility and performance on select professional applica 4600. <b>NOTE 2:</b> These processors support either ECC or non-ECC men <b>NOTE 3:</b> These processors support only non-ECC memory	ations, comp		

#### Monite

tors / Displays		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP DreamColor LP2480zx Professional Display HP Z Display Z30i 30-inch IPS LED Backlit Monitor HP Z Display Z27i 27-inch IPS LED Backlit Monitor HP Z Display Z24i 24-inch IPS LED Backlit Monitor HP Z Display Z23i 23-inch IPS LED Backlit Monitor HP Z Display Z22i 21.5-inch IPS LED Backlit Monitor HP ZR2740w 27-inch LED Backlit IPS Monitor				
	HP ZR2440w 24-inch LED Backlit IPS Monitor HP ZR2440w 24-inch LED Backlit IPS Monitor HP ZR2330w 23-inch IPS LED Backlit Monitor Supported by all Operating Systems available from HP				
	Supported by all operating systems available non-m				

Screen Size Diagonally Measured

#### **Hard Drives**

SATA Hard Drives		Factory		Option Kit	Cuppert
		Factory Configured	Option Kit	Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA	
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QF298AA	

#### Sub-Section Note: The 2.5" internal drive bay on the Z230 SFF only supports a Solid State Drive, and not a 10K rpm **Description/Notes** HDD.

SATA Solid State Drives	HP Solid State Drives (SSDs) for Workstations			
	HP 128GB SATA 6Gb/s SSD	Y	Y	A3D25AA
	HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
	HP 256GB SATA 6Gb/s SED SSD	Y	Y	(not available as After Market Option)



#### **Supported Components**

	HP 512GB SATA 6Gb/s SSD	Y	Y	D8F30AA
	HP 1TB SATA 6Gb/s SSD	Y	Y	F3C96AA
	Intel Pro 1500 180GB SATA SSD	Y	Y	F5Z70AA
	Samsung Enterprise 240GB SATA SSD	Y	Y	FOW94AA
	Samsung Enterprise 480GB SATA SSD	Y	Y	TBD
Intelligent Disk Caching	g Intelligent Disk Caching			
	64GB SSD Disk Cache Module	Y	Ν	(not
				available
				today as After
				Market
				Option)
PCIe SSDs	PCIe SSDs for HP Workstations			
	HP Z Turbo Drive 512GB SSD*	Y	Y	G3G89AA
	HP Z Turbo Drive 256GB SSD*	Y	Y	G3G88AA

\* Each drive requires a PCIe x4 (minimum) slot to be available. Full performance is obtained only when using PCIe slots connected to the CPU. Non-CPU PCIe slots may see a decrease of up to 10%. Please see slot configuration recommendations at www.hp.com/go/zturbo. Note that graphics cards, Thunderbolt™, and other devices will require PCIe slots.

Hard Drive Controllers		Factory Configured	Option Kit	Support Notes
	Integrated SATA Controller (Z230)			
	Integrated SATA Controller, RAID 0,1 supported: 5x 6 Gb/s ports	Y	Ν	
	Factory integrated RAID on motherboard for SATA drives			
	RAID 0 Configuration – Striped Array	Y	Ν	
	RAID 1 Configuration – Mirrored Array	Y	Ν	
	NOTE 1: Windows OS only; Supported only with two drives of identi	cal type and cap	acity.	

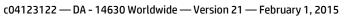
SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit <a href="http://h2000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf">http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf</a> for RAID capabilities with Linux.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supp # of cards	orted Mixed
	Integrated Intel HD Graphics Media	a Accelerators	(Z230)				
	Intel HD Graphics P4600	Y	Ν		Available on Intel® Xeon® E3- 12x5 v3 processors only. See Note 1.	1	NO
	Intel HD Graphics 4600	Y	Ν		Available on Intel CoreTM i7- 4xxx/ Core	1	NO



#### **Supported Components**

			( pro 5 1 ( Cc 4) i! ( 0 pro	5-4xxx/ Core i3- 4330 ocessors. ee Note Available on Intel oreTM i7- cxx/ Core 5-4xxx/ Core i3- 4330 ocessors. e Note 1.		
Intel HD Graphics 4400	Y	Ν	A ( ( pr	vailable on Intel Core i3- 4130 ocessor. e Note 1.	1	NO
Intel HD Graphics	Y	Ν	e P pr	vailable on Intel entium® 3220 ocessor. ee Note 1	1	NO
Professional 2D						
NVIDIA NVS 310 512MB Graphics	Y	Y	m	Can be ixed with one NVS 510	2	YES
NVIDIA NVS 315 1GB Graphics	Y	Y	E1U66AA		2	NO
NVIDIA NVS 510 2GB Graphics	Y	Y	m	Can be ixed with one NVS 310	1	YES
Graphics Cable Adapters						
HP DisplayPort To DVI-D Adapter	Y	Y	FH973AA		1	
HP DisplayPort To DVI-D Adapter (2- Pack)	Y	Ν			1	
HP DisplayPort To DVI-D Adapter (4- Pack)	Y	Ν			1	
HP DisplayPort To VGA Adapter	Y	Y	AS615AA		1	
HP DisplayPort to Dual Link DVI Adapter	Y	Y	NR078AA		1	
Entry 3D						
AMD FirePro V3900 1GB Graphics	Y	Y	A6R69AA		1	NO
AMD FirePro W2100 2GB Graphics	Y	Y	J3G91AA		2	





#### **Supported Components**

	HP Thin USB Powered Speakers, Low I	Halogen		<b>Configured</b> Y	Kit Y	<b>Number</b> KK912AA	Notes
Multimedia and Audio Devices				Factory	Option	Option Kit Part	Support
	<b>NOTE:</b> Only unbuffered DDR3 DIMMs		rted.				
	HP 4GB (1x4GB) DDR3-1600 ECC RAM			A2Z4	-		
	HP 8GB (1x8GB) DDR3-1600 ECC RAM			A2Z5	DAA		
	DDR3-1600 ECC Unbuffered DIMMs -						
	HP 4GB (1x4GB) DDR3-1600 nECC RA			B155			
	HP 8GB (1x8GB) DDR3-1600 non-ECC			B1S5	444		
	DDR3–1600 nECC Unbuffered DIMMs	ΑΜΟ		nulli			
	AMO			Option K Num		Suppor	t Notes
	Two channels of DDRS memory are so inserted into each channel. The CPUs determine the speed at whi the system, the maximum speed the of the memory.	ch the me	mory is clo	ocked. If a 13	33 MHz caj	pable CPU is	used in
	Sub-Section Description/Notes Two channels of DDR3 memory are su	Inported	To roalizo	full porform	nco at loa		Imusthe
	HP 4GB (2x2GB) DDR3-1600 ECC RAM						
	HP 8GB (1x8GB) DDR3-1600 ECC RAM HP 4GB (2x2GB) DDR3-1600 ECC RAM						
	HP 8GB (2x4GB) DDR3-1600 ECC RAM						
	HP 16GB (4x4GB) DDR3-1600 ECC RAI						
	HP 16GB (2x8GB) DDR3-1600 ECC RA						
	HP 32GB (4x8GB) DDR3-1600 ECC RA						
	DDR3-1600 ECC Unbuffered DIMMs -						
	HP 4GB (1x4GB) DDR3-1600 nECC RAI						
	HP 8GB (2x4GB) DDR3-1600 nECC RA						
	HP 16GB (4x4GB) DDR3-1600 nECC R						
	HP 16GB (2x8GB) DDR3-1600 nECC R/						
	HP 32GB (4x8GB) DDR3-1600 nECC R/						
	DDR3-1600 nECC Unbuffered DIMMs						
	СТО					Suppor	t Notes
	Intel® Xeon E3, Intel Core i3 and Intel Intel® Core i5/i7 processors only supp				either ECC	or non-ECC	memory;
lemory	Sub-Section Description/Notes						
	Note 1: Intermixing integrated Intel HD three displays can be enabled using the only discrete graphics cards when four	Compute	er (F10) Se	tup Utility. Ho	wever, HF	o recommen	
	NVIDIA Quadro K620 2GB Graphics	Y	Y	J3G87AA		1	
	NVIDIA Quadro K600 1GB Graphics	Y	Y	C2J92AA		1	NO
	NVIDIA Quadro K420 1GB Graphics	Y	Y	J3G86AA		1	NO



Integrated Realtek HD ALC221 Audio

Υ

Ν

#### **HP Z230 SFF Workstation**

#### **Supported Components**

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non Lightscribe)	Y	Y	AR629AA	
	HP 16X DVD+/-RW SuperMulti SATA Drive	Y	Y	QS208AA	
	HP Blu-ray Writer	Y	Y	AR482AA	
	HP 15-in-1 Media Card Reader	Y	Y	F4N90AA	
	lawful uses. Double Layer discs can store more data the discs burned with this drive may not be compatible with players.	th many existing	single-lay	er DVD drive	es and
	discs burned with this drive may not be compatible wi	th many existing es, certain disc, di stitute defects in u-ray titles to pla	single-lay igital conr the produ y, they ma	er DVD drive ection, com ct. Flawless ay require a	es and patibility playback DVI or
Controller Cards	discs burned with this drive may not be compatible wir players. As Blu-ray is a new format containing new technologie and/or performance issues may arise, and do not cons on all systems is not guaranteed. In order for some Blu HDMI digital connection and your display may require	th many existing es, certain disc, di stitute defects in u-ray titles to pla	single-lay igital conr the produ y, they ma	er DVD drive ection, com ct. Flawless ay require a	es and patibility playback DVI or
Controller Cards	discs burned with this drive may not be compatible wir players. As Blu-ray is a new format containing new technologie and/or performance issues may arise, and do not cons on all systems is not guaranteed. In order for some Blu HDMI digital connection and your display may require	th many existing es, certain disc, di stitute defects in u-ray titles to pla HDCP support. HI <b>Factory</b>	single-lay igital conr the produ y, they ma D-DVD mo <b>Option</b>	er DVD drive lection, com ct. Flawless ay require a vies cannot <b>Option</b> <b>Kit Part</b>	es and patibility playback DVI or be played Support Notes

USB 3.0 ports are supported under Microsoft Windows 7 or Microsoft Windows 8 operating systems only.

**NOTE 2:** Thunderbolt<sup>™</sup> 2 is available via an optional add-in card. Thunderbolt is new technology. Thunderbolt cable and Thunderbolt device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt Certified for Windows, see <a href="https://thunderbolttechnology.net/products">https://thunderbolttechnology.net/products</a>

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel I217LM PCIe GbE Controller	Y	Ν	Ν	See Notes 1, 2, 3
	Intel Ethernet I210-T1 PCIe NIC	Y	Y	E0X95AA	See Notes 3, 4
	Intel 6205 802.11 a/b/g/n PCIe x1 WLAN Card	Ν	Y	E0X93AA	
	<b>NOTE 1</b> : The integrated network connection is requi <b>NOTE 2</b> : If AMT is enabled network teaming with the <b>NOTE 3</b> : "Gigabit" Ethernet indicates compliance wit does not connote actual operating speed of 1 Gb/se Gigabit Ethernet server and network infrastructure	e integrated LAN po h IEEE standard 80 c. For high speed tr	rt is not p 2.3ab for	ossible. Gigabit Ethe	

**NOTE 4**: The Intel Ethernet I210-T1 PCIe NIC is supported on the following operating systems:

- Microsoft Windows 7 and Windows 8 32-bit and 64-bit versions
- Red Hat Enterprise Linux(RHEL)



#### **Supported Components**

• SLED 11.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solenoid Lock and Hood (SFF) Sensor	Y	Y	E0X97AA	
	HP Business PC Security Lock Kit	Ν	Y	PV606AA	The HP Business PC Security Lock Kit does not work with the Integrated Work Center stand.
	HP UltraSlim Cable Lock Kit	Ν	Y	H4D73AA	

Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP SpacePilot Pro 3D USB Intelligent Controller	Ν	Y	WH343AA	
	HP SpaceMouse Pro USB 3D Input Device	Ν	Y	B4A20AA	
	HP USB 1000dpi Laser Mouse	Y	Y	QY778AA	
	HP USB Optical 3-Button Mouse	Y	Y	DY651A	
	HP USB Optical Mouse	Y	Y	QY777AA	
	HP PS/2 Mouse	Y	Y	QY775AA	
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Y	NB896AA	
	HP USB CCID SmartCard Keyboard	Y	Y	BV813AA	
	HP USB Keyboard	Y	Y	QY776AA	
	HP PS/2 Keyboard	Υ	Y	QY774AA	

Other Hardware				<b>Option Kit</b>	
		Factory Configured	Option Kit	Part Number	Support Notes
	HP Power Cord Kit	Ν	Y	DM293A	
	HP Workstation Mouse Pad	Y	Ν		Japan only
	HP Serial Port Adapter	Y	Y	PA716A	
	HP ENERGY STAR Qualified Configuration	Y	Ν		
	HP Parallel Port Adapter Kit	Ν	Y	KD061AA	
	HP Internal USB Port Kit	Ν	Y	EM165AA	
	HP eSATA PCI Cable Kit	Y	Y	FH966AA	
	HP (SFF) Tower Stand	Y	Y	VN569AA	
Software		Factory	Option	Suppor	rt Notes



#### Supported Components

	Configured	Kit	
HP Performance Advisor	Y	Ν	See Note 1
HP Remote Graphics Software (RGS) 6.0	Y	Ν	See Note 2
PDF Complete - Corporate Edition	Y	Ν	
MS Office Home & Business 2013	Y	Ν	
Cyberlink PowerDVD and Power2Go	Y	Ν	
HP PC Hardware Diagnostics UEFI	Y	Ν	Windows OS only
HP Client Security Software	Y	Υ	

NOTE 1: Supports, and preinstalled with, Windows 7 and Windows 8 only. Also available as a free download from www.hp.com/go/performanceadvisor **NOTE 2**: Supported Operating Systems:

- Windows 7 Professional
- Windows 8 Pro .
- RHEL v5.2 v6.3
- SLED 11 SP2

#### **Operating Systems**

#### **Support Notes** Genuine Windows<sup>®</sup> 7 Professional 32-bit See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for support details. See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> Genuine Windows<sup>®</sup> 7 Professional 64-bit for support details. Windows 8.1 Pro 64-bit Windows 8.1 Simplified Chinese Edition 64bit Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit (National Academic) Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit (National Academic) **HP Linux Installer Kit** See http://h20331.www2.hp.com/hpsub/cache/537200-0-0-225-121.html Red Hat Enterprise Linux (RHEL) See http://www.redhat.com/rhel/desktop/ Workstation - Paper License (1yr) SUSE Linux Enterprise Desktop 11 See http://www.suse.com/products/desktop/ Ubuntu Linux 14.04



System Board				
System Board Form Factor	ATX 24.38 x 24.38 mm (9.6 x 9.	6 inches)		
Processor Socket	Single LGA 1150			
CPU Bus Speed	DMI			
Chipset	Intel <sup>®</sup> PCH C226			
Memory Expansion Slot	s 4 DDR3 memory slots			
Memory Type Supported	d DDR3, UDIMM (Unbuffered), ECC	& non-ECC		
Memory Modes	Non-Interleaved for single chan	nel. Interleaved when both channels are populated.		
Memory Speed Supported	1600MHz DDR3	500MHz DDR3		
Memory Protection	ECC available on data			
Maximum Memory	32GB			
Memory Configuration (Supported)	ECC and non-ECC memory DIMM	4GB and 8GB non-ECC/ 2GB, 4GB and 8GB ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed on the same system.		
		acities assume 64-bit operating systems, such as Genuine Windows® 7 .inux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.		
	• 1 PCI Express Gen2 x1	5 LP slot (x4 electrical/x16 mechanical) LP slot (x1 electrical/x4 mechanical)		
	<b>NOTE:</b> LP = Low Profile <b>NOTE:</b> In the PCIe Gen3 slot (x1)	LP slots (x1 electrical/x1 mechanical) 5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported.		
Supported Drive Interfaces	<b>NOTE:</b> LP = Low Profile <b>NOTE:</b> In the PCIe Gen3 slot (x1)			
	<b>NOTE:</b> LP = Low Profile <b>NOTE:</b> In the PCIe Gen3 slot (x10 card, only cards certified as Afte	5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported. Integrated (5) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA. RAID 0 and 1 supported. Factory integrated RAID is Microsoft		
	NOTE: LP = Low Profile NOTE: In the PCIe Gen3 slot (x10 card, only cards certified as Afte SATA	5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported. Integrated (5) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA. RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only.		
	NOTE: LP = Low Profile NOTE: In the PCIe Gen3 slot (x10 card, only cards certified as Afte SATA Serial Attached SCSI	5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported. Integrated (5) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA. RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only. None NOTE: Requires identical hard drives (speeds, capacity,		
	NOTE: LP = Low Profile NOTE: In the PCIe Gen3 slot (x10 card, only cards certified as Afte SATA Serial Attached SCSI Integrated RAID	5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported.         Integrated (5) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA.         RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only.         None         NOTE: Requires identical hard drives (speeds, capacity, interface)         Integrated Intel HD Graphics 4600 (on Core i5/i7-4xxx processors); Integrated Intel HD Graphics P4600 (on Intel Xeon E3-12x5v3 processors).         Based on Unified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display.         Support for Microsoft DirectX 11, OpenGL 4.0 and OpenCL 1.2 on Intel HD Graphics P4600; 3 DP 1.2 graphics ports integrated in motherboard; Supports up to three simultaneous displays across DP outputs. Max.		
	NOTE: LP = Low Profile NOTE: In the PCIe Gen3 slot (x10 card, only cards certified as Afte SATA Serial Attached SCSI Integrated RAID	5 electrical/x16 mechanical) slot, if it is not being used for a graphics er Market Options for this platform are supported.         Integrated (5) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA.         RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only.         None         NOTE: Requires identical hard drives (speeds, capacity, interface)         Integrated Intel HD Graphics 4600 (on Core i5/i7-4xxx processors); Integrated Intel HD Graphics P4600 (on Intel Xeon E3-12x5v3 processors).         Based on Unified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display.         Support for Microsoft DirectX 11, OpenGL 4.0 and OpenCL 1.2 on Intel HD Graphics P4600; 3 DP 1.2 graphics ports integrated in motherboard; Supports		



		Option cable kit.	
	IDE connector	No	
	Floppy connector	No	
	Serial	1 rear port	
	2nd Serial	Yes- requires optional Serial Port Adapter Kit	
	Parallel	1 internal header (optional Parallel Port Adapter required)	
	CD-ROM input (Audio)	No	
	AUX input (Audio)	No	
IEEE 1394 Connector(s)	Rear	2 IEEE 1394b (requires optional PCIe 1394b card)	
	Internal	No	
USB Connector(s)	Front	2 USB 3.0, 2 USB 2.0	
	Rear	2 USB 3.0, 4 USB 2.0	
	Internal	1 USB 3.0, 2 USB 2.0	
HD Integrated Audio	Yes		
Flash ROM	Yes, 16MB		
Chassis Fan Header	Not applicable		
Front Control Panel/Speaker Header	Yes		
CMOS Battery Holder -	Yes		
Lithium			
Integrated Trusted Platform Module	Integrated TPM 1.2.		
Power Supply Headers	Yes		
Power Switch, Power LED & Hard Drive LED Header	Yes		
Clear Password Jumper	Yes		
Keyboard/Mouse	USB or PS/2		
	240W, 92% efficiency, wide-ranging, active PFC Power Supply; (Note: 240W Standard Efficiency wide-ranging, active PFC Power Supply option available in some countries). The Z230 SFF 92% PSU Efficiency Report can be found at these links: <u>http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_PS-4241-</u> <u>1HA_240W_ECOS%203449_Report.pdf</u> <u>http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD_D12-</u> <u>240P2A_240W_ECOS%203384_Report.pdf</u>		
	http://www.pluqloadsolutions.com/psu_reports/Hewlett-Packard%20Company_DPS-240AB- 3%20A_240W_ECOS%203416_Report.pdf http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_PCC002- 020H2_240W_ECOS%203440_Report.pdf		
Operating Voltage Range	90-269 VAC		
Rated Voltage Range	100-240 VAC		
<b>Rated Line Frequency</b>	50-60 Hz		



### System Technical Specifications

Operating Line Frequency Range	47-63 Hz
Rated Input Current	4A @ 100-240V
Heat Dissipation	Typical: 444 btu/hr (112 kcal/hr) Maximum: 890 btu/hr (224 kcal/hr)
Power Supply Fan	70x25 mm variable speed
<b>ENERGY STAR® qualified</b> (Config Dependent)	Yes
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
Built-in Self Test (BIST) LED	Νο
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5- Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5- Power Off)	Yes

#### **System Configurations**

Z230 SFF Configuration	Processor Info	1x Intel Core i3-4xxx 3.x xMB 2C HT xxW GT1 CPU
#1	Memory Info	4GB (1x 4GB) 1600 MHz DDR3 non-ECC
	Graphics Info	Intel Integrated Graphics
	Disks/Optical/Floppy	1x SATA 500 GB 7.2k rpm/ 1x DVD-RW
	PSU	240W 92%
	OS /BIOS	

Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)						
	Windows Busy Typ (SO)						
	Windows Busy Max (SO)						
	Sleep (S3)						
	Off (S5)						
	Zero Power Mode (EuP)						
Heat Dissipation		115	VAC	230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)						
	Windows Busy Typ (SO)						
	Windows Busy Max (SO)						
	Sleep (S3)						



	Off (S5)	
	Zero Power Mode (EuP)	
Z230 SFF Configuration	Processor Info	1x Intel Xeon E3-1280v3 3.6 8MB 4C HT 84W GT0 CPU
#2 Memory Info 8GB (2x 4GB) 1600 MHz DDR3 E		8GB (2x 4GB) 1600 MHz DDR3 ECC
	Graphics Info	1x NVIDIA Quadro K600 1GB Graphics
	Disks/Optical/Floppy	1x SATA 2 TB 7.2k rpm/ 1xDVD-RW
	PSU	240W 92%
	OS /BIOS	

Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)	Watts)		LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	32.7 W		32.7 W		32.6 W	
	Windows Busy Typ (SO)	13	1 W	130	D W	130 W	
	Windows Busy Max (SO)	154	4 W	151 W		15	5 W
	Sleep (S3)	2.05 W	1.95 W	2.18 W	2.08 W	2.03 W	1.93 W
	Off (S5)	0.83 W	0.76 W	0.95 W	0.88 W	0.82 W	0.75 W
	Zero Power Mode (EuP)	0.2	3 W	0.3	4 W	0.2	2 W
Heat Dissipation		115	VAC	230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	112 b	otu/hr	112 b	otu/hr	111 b	otu/hr
	Windows Busy Typ (SO)	447 b	otu/hr	444 b	otu/hr	444 b	otu/hr
Windows Busy Max (SO)		525 b	otu/hr	515 b	otu/hr	529 b	otu/hr
	Sleep (S3)	6.99 btu/hr	6.65 btu/hr	7.44 btu/hr	7.10 btu/hr	6.93 btu/hr	6.95 btu/hr
	Off (S5)	2.83 btu/hr	2.59 btu/hr	3.24 btu/hr	3.00 btu/hr	2.80 btu/hr	2.56 btu/hr
	Zero Power Mode (EuP)	0.78 t	otu/hr	1.16 t	otu/hr	0.75 t	otu/hr

Z230 SFF Configuration	Processor Info	1x Intel Xeon E3-1280v3 3.6 8MB 4C HT 84W GT0 CPU
#3	Memory Info	32GB (4x 8GB) 1600 MHz DDR3 ECC
	Graphics Info	1x NVIDIA Quadro K600 1GB Graphics
	Disks/Optical/Floppy	2x SATA 2 TB 7.2k rpm/ 1xDVD-RW
	PSU	240W 92%
	OS /BIOS	

Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	38.	8 W	38.	7 W	38.	9 W
	Windows Busy Typ (SO)	142	2 W	14(	D W	14	W
	Windows Busy Max (SO)	164	4 W	16	1 W	16	5 W
	Sleep (S3)	2.87 W	2.75 W	3.01 W	2.90 W	2.86 W	2.75 W
	Off (S5)	0.83 W	0.76 W	0.95 W	0.88 W	0.82 W	0.75 W
	Zero Power Mode (EuP)	0.2	3 W	0.3	4 W	0.2	2 W
Heat Dissipation		115	VAC	230	VAC	100	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	132 t	otu/hr	132 b	tu/hr	133 b	tu/hr



#### System Technical Specifications

Windows Busy Typ (SO)	485 btu/hr		478 btu/hr		481 btu/hr	
Windows Busy Max (S0)	560 b	otu/hr	549 b	tu/hr	563 b	tu/hr
Sleep (S3)	9.79 btu/hr	9.38 btu/hr	10.3 btu/hr	9.90 btu/hr	9.76 btu/hr	9.38 btu/hr
Off (S5)	2.83 btu/hr	2.59 btu/hr	3.24 btu/hr	3.00 btu/hr	2.80 btu/hr	2.56 btu/hr
Zero Power Mode (EuP)	0.78 t	otu/hr	1.16 t	otu/hr	0.75 t	otu/hr

Declared Noise Emissions (Entry-level and High-end configurations)

System Configuration	Processor Info	Intel Core i3-4130
(Entry level)	Memory Info	4GB (2x2GB) 1600 MHz
	Graphics Info	Integrated Intel HD Graphics 4400
	Disks/Optical	1x 500 GB 7200 RPM SATA HDD; DVD-RW SuperMulti ODD

<b>Declared Noise Emissions</b> (in accordance with ISO		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
7779 and ISO 9296)	Idle	3.3	
	Hard drive Operating (random reads)	3.3	
	<b>DVD-ROM Operating</b> (sequential reads)		

System Configuration	Processor Info	Intel Xeon E3-1280v3 3.6 GHz
(High-end)	Memory Info	4 x 4GB DDR3 1600 MHz
	Graphics Info	NVIDIA Quadro K600 graphics
	Disks/Optical	2x 500GB 10K rpm SATA HDDs; SATA Blu-ray ODD

<b>Declared Noise Emissions</b> (in accordance with ISO		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
7779 and ISO 9296)	Idle	3.4	
	Hard drive Operating (random reads)	3.5	
	DVD-ROM Operating (sequential reads)		

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	<b>Dynamic</b> (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g)



	square: 422 cm/s, 20g
	Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz
	<b>NOTES:</b> Values represent individual shock events and do not indicate repetitive shock events. Values do not indicate continuous vibration.
Cooling	Above 5,000 ft (1524 m) altitude, maximum operating temperature is de- rated by 1.8° F (1° C) per 1,000 ft (305 m) elevation increase

Physical Security a	nd Serviceability					
Access Panel	Tool-less					
	Includes system board and memory information					
Hard Drives	Tool-less (Internal bays)					
Expansion Cards	ool-less					
Processor Socket	ool-less, except for the processor heatsink.					
Green User Touch Points	Yes, on tool-free internal chassis mechanisms					
Color-coordinated Cables and Connectors	Yes					
Memory	Tool-less					
System Board	Screw-In					
Dual Color Power and HD LED on Front of Computer	Yes					
<b>Configuration Record SW</b>	Yes					
Over-Temp Warning on Screen	Yes					
Restore CD/DVD Set	Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.					
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds					
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system					
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system					
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system					
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.					
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft					
Serial, Parallel, USB, Audio, Network, Enable/Disable Port	Yes, enables or disables serial, USB, audio, and network ports					



Control							
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)						
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation						
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration						
3.3V Aux Power LED on System PCA	/es						
NIC LEDs (integrated) (Green & Amber)	/es						
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less						
Power Supply Diagnostic LED	Νο						
Front Power Button	Yes, ACPI multi-function						
Front Power LED	Yes, blue (normal), red (fault)						
Front Hard Drive Activity LED	Yes, green						
Front ODD Activity LED	Yes						
Internal Speaker	Yes						
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.						
Cooling Solutions	Air cooled forced convection						
Power Supply Fans	70mm x 70mm x 25mm 4-wire PWM (non-serviceable)						
CPU Heatsink Fan	ot applicable- CPU heatsink is passive.						
Chassis Fan	ot applicable. CPU heatsink fan also operates as the chassis fan.						
Memory Heatsink Fan	10						
HP PC Hardware Diagnostics UEFI	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.						
Access Panel Key Lock	No						
ACPI-Ready Hardware	<ul> <li>Advanced Configuration and Power Management Interface (ACPI).</li> <li>Allows the system to wake from a low power mode.</li> <li>Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system</li> </ul>						
Trusted Platform Module Chip with optional ProtectTools Software	Yes						
Integrated Chassis Handles	Νο						
Power Supply	Requires T15 Torx or flat blade screwdriver						
PCI Card Retention	Yes, rear (all), middle (none), front (none)						
Flash ROM	Yes						
Diagnostic Power Switch LED on board	Yes						
Clear Password Jumper	Yes						



Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes
HP ProtectTools Security	Yes - Not supported on Microsoft XP x64 or Linux
Manager	

BIOS						
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4					
PCI 3.0 Support	full BIOS support for PCI Express through industry standard interfaces.					
ATAPI	TAPI Removable Media Device BIOS Specification Version 1.0.					
BBS	IOS Boot Specification v1.01. rovides more control over how and from what devices the workstation will boot.					
WMI Support	/MI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is ully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) nd WBEM specifications.					
BIOS Power On	Users can define a specific day-of-week and time for the system to power on.					
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.					
System/Emergency ROM Flash Recovery with Video	ecovers system BIOS in corrupted Flash ROM.					
Replicated Setup	aves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate hese settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).					
SMBIOS	System Management BIOS 2.7.1, for system management information.					
Boot Control	sables the ability to boot from removable media on supported devices.					
Memory Change Alert	lerts management console if memory is removed or changed.					
Thermal Alert	Monitors the temperature state within the chassis. Three modes:					
	<ul> <li>NORMAL - normal temperature ranges.</li> <li>ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.</li> </ul>					
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console. Updates can be performed before starting the OS. Updates can be periodically scheduled.					
<b>ACPI</b> (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 4.0 for full compatibility with 64-bit operating systems.					
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.					
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.					
	System administrators can power on, restart, and power off a client computer from a remote location. No.					



(Suspend to RAM - ACPI sleep state S3)					
<b>Remote System</b> Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.				
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.				
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.				
<b>Start-up Diagnostics</b> (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.				
Auto Setup when new hardware installed	System automatically detects addition of new hardware.				
<b>Keyboard-less Operation</b>	The system can be booted without a keyboard.				
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.				
Asset Tag	The user or IT administrator to set a unique tag string in non-volatile memory.				
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable) to be configured individually.				
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.				
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.				
Intel® Active Management Technology (AMT)	AMT 9.0; Allows workstation status to be monitored on a remote console				
	Helps to prevent the installation of unauthorized versions of a BIOS (a rogue BIOS) from a virus, malware, or other code that could lead to compromised system security, data access, physical service, or even system board replacement.				
Master Boot Record Protection	A feature in the HP BIOS that prevents changes and/or infections to the Master Boot Record. Useful in protecting from viruses.				
Boot Block Emergency Recovery Mode (BIOS Recovery)	The HP BIOS offers a write-protected boot block ROM that provides recovery from a failed flashing of the computer BIOS. This special recovery mode prevents the system from becoming unusable or "bricked" when a BIOS update is interrupted.				
Industry Standard Specification Support					
Industry Standard	Revision Supported by the BIOS				
UEFI Specification Revision	UEFI 2.3.1				
ACPI	Advanced Configuration and Power Management Interface, Version 4.0				
ASF	Alert Standard Format Specification, Version 2.0				
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b				
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0				
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0				
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0				
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0				



	PCI Express Base Specification, Revision 3.0.					
РММ	POST Memory Manager Specification, Version 1.01					
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATAII: Extensions to Serial ATA 1.0, Revision 1.0a - Serial ATAII Cables and Connectors Volume 2 Gold - SATA-IO SATA Revision 3.0 Specification					
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B					
ТРМ	Trusted Computing Group TPM Specification Version 1.2					
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification					

Social and Environ	nental Responsibility			
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:			
	<ul> <li>ENERGY STAR<sup>®</sup> (energy-saving features available on selected configurations -Windows only)</li> <li>US Federal Energy Management Program (FEMP)</li> <li>China Energy Conservation Program (CECP)</li> <li>IT ECO declaration</li> </ul>			
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal			
	The battery in this product does not contain:			
	<ul> <li>Mercury greater than 5ppm by weight</li> <li>Cadmium greater than 10ppm by weight</li> <li>Lead greater than 40ppm by weight</li> </ul>			
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. <u>http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf</u> Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.			
Low Halogen Statement	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card is not Low Halogen. Service parts obtained after purchase may not be Low Halogen.			
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <u>http://www.hp.com/recycle</u> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner This product is greater than 90% recyclable by weight when properly disposed of at end of life.			
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report <u>http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</u>			
	Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html			
	ISO 14001 certificates:			



### System Technical Specifications

	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html				
Additional Information	<ul> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.</li> <li>This product is &gt;90% recycle-able when properly disposed of at end of life</li> <li>EPEAT Gold registered in the U.S. EPEAT registration varies by country. See <u>www.epeat.net</u> for registration status by country.</li> </ul>				
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html				
	<ul> <li>Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment</li> <li>Does not contain ozone-depleting substances (ODS)</li> <li>Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess o 100 ppm sum total for all heavy metals listed</li> </ul>				
	<ul> <li>Maximizes the use of post-consumer recycled content materials in packaging materials</li> <li>All packaging material is recyclable</li> </ul>				
	<ul> <li>All packaging material is designed for ease of disassembly</li> </ul>				
	<ul> <li>Reduced size and weight of packages to improve transportation fuel efficiency</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting</li> </ul>				
Packaging Materials					
Internal	Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expanded- polypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).				
External	Carton made from corrugated fiberboard with at least 25% recycled content.				

#### Manageability

manayeavility	
Intel Active Management Technology (AMT)	An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 8.0 includes the following advanced management functions:
	<ul> <li>Power Management (on, off, reset)</li> <li>Hardware Inventory (includes BIOS and firmware revisions</li> <li>Hardware Alerting</li> <li>Agent Presence</li> </ul>
	<ul> <li>System Defense Filters</li> <li>SOL/IDER</li> <li>Cisco NAC/SDN Support</li> <li>ME Wake-on-LAN</li> </ul>
	<ul> <li>DASH 1.1 compliance</li> <li>IPv6 Support</li> <li>Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection</li> </ul>
	<ul> <li>Remote Scheduled Maintenance - pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient</li> <li>Remote Alerts - automatically alert IT or service provider if issues arise</li> <li>Access Monitor - Provides oversight into Intel<sup>®</sup> AMT actions to support security requirements</li> </ul>



	<ul> <li>PC Alarm Clock</li> <li>Microsoft NAP Support</li> <li>Host Base set-up and configuration</li> <li>Management Engine (ME) firmware roll back</li> <li>Wireless AMT functionality on Desktop (WoDT)</li> <li>Enhanced KVM resolution</li> </ul>						
Intel® vPro™ Technology	The HP Z230 workstations support Intel vPro technology when purchased with a vPro technology capable CPU: Intel® Xeon® processor E3-1200v2 family or 3rd Generation Intel Core i5/i7 processors with Intel VT and Intel TXT technology						
Remote Manageability Software Solutions	Visit: <u>http://www.hp.com/go/easydeploy</u>						
System Software Manager	Visit: <u>http://www.hp.com/go/ssm</u>						
Service, Support, and Warranty	<ul> <li>Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.</li> <li>PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.</li> <li>Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.</li> </ul>						



#### **Technical Specifications - Processors**

Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1281v3, Quad-Core, 8 MB cache, 3.7 GHz, up to 4.1 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1271v3, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1270v3, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1270v3, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1246v3, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1245v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1240v3, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1240v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1240v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1230v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1230v3, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.7 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1230v3, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1226v3, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1226v3, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1226v3, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1226v3, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1225v3, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Xeon<sup>®</sup> processor E3-1225v3, Qua

Intel<sup>®</sup> Core<sup>™</sup> i7-4790 processor, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i7-4771 processor, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i5-4690 processor, Quad-Core, 6 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i5-4670 processor, Quad-Core, 6 MB cache, 3.4 GHz, up to 3.9 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i5-4670 processor, Quad-Core, 6 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i5-4590 processor, Quad-Core, 6 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i5-4570 processor, Quad-Core, 6 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology Intel<sup>®</sup> Core<sup>™</sup> i3-4350 processor, Dual-Core, 4 MB cache, 3.6 GHz Intel<sup>®</sup> Core<sup>™</sup> i3-4300 processor, Dual-Core, 3 MB cache, 3.6 GHz Intel<sup>®</sup> Core<sup>™</sup> i3-4160 processor, Dual-Core, 4 MB cache, 3.5 GHz Intel<sup>®</sup> Core<sup>™</sup> i3-4150 processor, Dual-Core, 4 MB cache, 3.5 GHz Intel<sup>®</sup> Core<sup>™</sup> i3-4130 processor, Dual-Core, 4 MB cache, 3.5 GHz

Intel<sup>®</sup> Pentium<sup>®</sup> G3240 processor, Dual-Core, 3 MB cache, 3.1 GHz Intel<sup>®</sup> Pentium<sup>®</sup> G3220 processor, Dual-Core, 3 MB cache, 3.0 GHz



### Technical Specifications - Hard Drives

SATA Hard Drives for HP	-	Capacity	500GB	
Workstations	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), N	CQ enabled
		<b>Synchronous Transfer</b> Rate (Maximum)	Up to 600MB/s	
		Buffer	16MB	
		Seek Time (typical reads,	Single Track	2 ms
		includes controller	Average	11 ms
		overhead, including settling)	Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperature	41° to 131° F (5° to 55°	C)
	1TB SATA 7200 rpm	Capacity	1 Terabyte (1000 GB)	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
	-	Width	Media Diameter	3.5 in; 8.9 cm
		with	Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), N	
		Synchronous Transfer	Up to 600 MB/s	
		Rate (Maximum)		
		Buffer	32MB	2
		Seek Time (typical reads, includes controller	Single Track	2 ms
		overhead, including settling)	Average Full Stroke	11 ms 21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	1,953,525,168	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Operating Temperature	41° to 131° F (5° to 55° C)	
		Capacity	2TB	
		Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0 Gb/s), N	CQ Enabled
		<b>Synchronous Transfer</b> Rate (Maximum)	Up to 600MB/s	
		Buffer	64MB	
		Seek Time (typical reads,	Single Track	1.0 ms
		includes controller	Average	11 ms
		overhead, including settling)	Full Stroke	18 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	3,907,029,168	
		Operating Temperature	41° to 131° F (5° to 55°	C)



#### **Technical Specifications - Hard Drives**

	3.0TB SATA 7200 rpm	Capacity	3.0TB	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4.0 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), N	
		<b>Synchronous Transfer</b> Rate (Maximum)	Up to 6.0 Gb/s	
		Buffer	64MB	
		Seek Time (typical reads,	Single Track	0.6 ms
		includes controller	Average	11 ms
		overhead, including settling)	Full Stroke	Not specified
		<b>Rotational Speed</b>	7200 rpm	
		Operating Temperature	41° to 140° F (5° to 60°	C)
HP Solid State Drives	HP 128GB SATA 6Gb/s	Capacity	128GB	
(SSDs) for Workstations	SSD	Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	SATA 6Gb/s	
		<b>Synchronous Transfer</b> Rate (Maximum)	Up to 500MB/s (Sequential Read)	
		Operating Temperature	32° to 158° F (0° to 70° C)	
	HP 256GB SATA 6Gb/s	Capacity	256GB	
	SSD	Height	0.28 in; 0.7 cm	
		Interface	SATA 6Gb/s	
		<b>Synchronous Transfer</b> <b>Rate</b> (Maximum)	Up to 500MB/s (Seque	ntial Read)
		Operating Temperature	32° to 158° F (0° to 70°	° C)
	HP 512GB SATA 6Gb/s	Capacity	512GB	
	SSD	Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)	
		Operating Temperature	32° to 158° F (0° to 70°	° C)
	HP 1TB SATA 6Gb/s SSD	Capacity	1TB	
		Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	6Gb/s SATA	
		<b>Synchronous Transfer</b> Rate (Maximum)	Up to 500MB/s (Sequer	ntial Read)
		Operating Temperature	ting Temperature 32° to 158° F (0° to 70° C)	

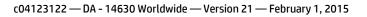


#### **Technical Specifications - Hard Drives**

	HP 256GB SATA 6Gb/s SED SSD	Capacity Height Width Interface Synchronous Transfer Rate (Maximum) Operating Temperature	256GB 0.28 in; 0.7 cm <b>Physical Size</b> 6Gb/s SATA Up to 550MB/s (Sequer 32° to 158° F (0° to 70°	
	Intel Pro 1500 180GB SATA SSD	Capacity Width Interface Synchronous Transfer Rate (Maximum)	180GB <b>Physical Size</b> 6Gb/s SATA 600 Mb/s	2.5 in; 6.36 cm
	Samsung Enterprise 240GB SATA SSD	Capacity Width Interface Synchronous Transfer Rate (Maximum)	240GB <b>Physical Size</b> SATA 6Gb/s Up to 600MB/s	2.5 in; 6.36 cm
	Samsung Enterprise 480GB SATA SSD	Capacity Width Interface Synchronous Transfer Rate (Maximum)	480GB <b>Physical Size</b> SATA 6Gb/s Up to 600MB/s	2.5 in; 6.36 cm
PCIe SSDs for HP Workstations	HP Z Turbo Drive 256GB SSD	Capacity Interface Operating Temperature	256GB PCI Express 2.0 x4 elec 32° to 158° F (0° to 70'	
	HP Z Turbo Drive 512GB SSD	Capacity Interface Operating Temperature	512GB PCI Express 2.0 x4 elec 32° to 158° F (0° to 70'	

NVIDIA NVS 310 512MB	Form Factor	Low Profile:	
Graphics		2.713 inches in height × 6.150 inches in length	
	Graphics Controller	NVIDIA NVS 310	
	Bus Type	PCI Express x16, 2.0 compliant	
	Memory	Size: 512MB DDR3	
		Clock: 875Mhz Memory Bandwidth: 14GB/s	
	Connectors	2 x DisplayPort 1.2	
	Maximum Resolution		
		Up to 2560 x 1600 (digital display) per display.	
	Image Quality Features	See Display Output section.	
		The following video formats are supported:	
		<ul> <li>MPEG2</li> <li>MPEG4 Part 2 Advanced Simple Profile</li> <li>H.264 SVC codec support</li> <li>Support for 3D Blu Ray</li> <li>VC1</li> <li>Nickersion 2.11 and later</li> </ul>	
		<ul> <li>DivX version 3.11 and later</li> <li>MVC</li> </ul>	
		A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.	
	Display Output	Up to 2 displays in the following configurations:	
		DisplayPort output:	
		<ul> <li>Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card</li> <li>Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.</li> </ul>	
		DVI-D output:	
		<ul> <li>Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors</li> <li>Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors</li> </ul>	
		HDMI output:	
		<ul> <li>NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI</li> </ul>	

		cable adaptors
		VGA display output:
		• Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	DX11, OpenGL 4.1
	Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		SUSE Linux Enterprise drivers may also be obtained from: <u>ftp://download.nvidia.com/novell</u> or <u>http://www.nvidia.com</u>
	Power Consumption	19.5 Watts
	Note	The thermal solution used on this card is an active fan heatsink.
NVIDIA NVS 315 1GB Graphics (for HP	Form Factor	Low Profile: 2.713 inches in height × 5.7 inches in length
Workstations)	Graphics Controller	NVIDIA NVS 315 (using GF119-825 GPU) Number of Cores: 48 CUDA cores Max. Power: 19.3W Cooling Solution: Active fan heatsink
	Bus Type	PCI Express x16, 2.0 compliant
	Memory	Size: 1GB DDR3 Clock: 875Mhz Memory Bandwidth: 14GB/s
	Connectors	DMS-59 output
		Cables included: - For CTO: DMS-59 to DVI cable - For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable
	<b>Maximum Resolution</b>	Maximum number of displays supported: 2
		Maximum Resolution Support:
		- DMS-59 to VGA: 2048 x 1536 @ 85Hz - DMS-59 to DVI: 1980 x 1200 @ 60Hz - DMS-59 to DP: 2560 x 1600 @ 60Hz
	Image Quality Features	See Display Output section.
		The following video formats are supported:
		- MPEG2 - MPEG4 Part 2 Advanced Simple Profile





Notes	<u>ftp://download.nvidia.com/novell</u> or <u>http://www.nvidia.com</u> The thermal solution used on this card is an active fan heatsink.	
	SUSE Linux Enterprise drivers may also be obtained from:	
	http://welcome.hp.com/country/us/en/support.html	
	HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:	
	SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)	
DIIVEIS	Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL)	
Available Graphics Drivers	Microsoft Windows 8 Microsoft Windows 7 Professional (64-bit and 32-bit)	
Supported Graphics APIs		
Shading Architecture	Shader Model 5.0	
	• Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.	
	VGA display output:	
	<ul> <li>Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor</li> </ul>	
	DVI-D output:	
	<ul> <li>Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.</li> </ul>	
	DisplayPort output:	
Display Output	provides improved video playback speeds via faster decode and transcode. Up to 2 displays in the following configurations:	
	A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as	
	- VC1 - DivX version 3.11 or later	
	- H.264 SVC codec support - Support for 3D Blu Ray	

NVIDIA NVS 510 2GB Graphics Form Factor Graphics Controller Low Profile, 2.713 inches × 6.3 inches, single slot NVS 510 GPU



	Core Clock: 797 Mhz Memory Clock: 891 Mhz CUDA Cores: 192
Bus Type	PCI Express x16, Generation 2.0
Memory	2GB DDR3
Connectors	Four mini-DisplayPort. Four mini-DisplayPort to DisplayPort adapters included. (DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)
Maximum Resolution	Mini-DisplayPort connectors support ultra-high-resolution panels (up to 3840 x 2160 @ 60Hz)
	<b>NOTE:</b> This card supports up to four displays. For Windows XP, only 2 active displays are supported.
Image Quality Features	10-bit internal display processing, including hardware support for 10-bit scan-out
Display Output	DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2) support.
	Digital Display Support
	<ol> <li>DisplayPort Output</li> <li>Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.</li> <li>DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.</li> </ol>
	<ul> <li>2. DVI-D Output</li> <li>Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.</li> <li>Drives four digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.</li> </ul>
	3. HDMI Output - The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.
	Analog Display Support
	1. VGA display output - Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors.
	Full Microsoft DirectX 11, Shader Model 5.0 support Full OpenGL 4.3 support
Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)



### **Technical Specifications - Graphics**

	Power Consumption Note	HP qualified drivers may be preloaded or available from the HP support Web site: <u>http://welcome.hp.com/country/us/en/support.html</u> 33.4 Watts Heatsink cooler design is active.
Graphics Cable Adapters	Notes	Graphics Cable Adapter option choice is available starting Feb 1 2013 for the following graphics cards: NVS 310, Quadro 410, Quadro K5000, FirePro V3900, FirePro W7000
		New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing Graphics Cable Adapters, unless otherwise specified.
		No cable choice for NVS 300, NVS 510.
		Maximum number of cables allowed is 8.
AMD FirePro V3900 1GB Graphics	Form Factor Graphics Controller	Full height, half length (full-height bracket included) AMD FirePro™ V3900 professional graphics
	Bus Type Memory	PCI Express® x16, Generation 2.1 1GB DDR3 memory
	Maximum Resolution Display Output	2560x1600 per display (5120x1600 max. horizontal resolution) 1 DisplayPort® 1.2 1 Dual-link DVI
	Shading Architecture	Shader Model 5.0
	<b>Supported Graphics APIs</b>	OpenCL™ 1.1, DirectX <sup>®</sup> 11 and OpenGL 4.2
	Available Graphics Drivers	Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
	Damas Consumption	HP qualified drivers may be preloaded or available from the HP support Web site: <u>http://welcome.hp.com/country/us/en/support.html</u>
	Power Consumption Note	<50W AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro <sup>™</sup> professional graphics card; the number of supported displays varies by card model. Microsoft <sup>®</sup> Windows <sup>®</sup> 7, Windows Vista <sup>®</sup> , or Linux <sup>®</sup> is required in order to support more than 2 displays. Depending on the card model, native DisplayPort <sup>™</sup> connectors and/or certified DisplayPort <sup>™</sup> active or passive adapters to convert your monitor's native input to your card's DisplayPort <sup>™</sup> or Mini-DisplayPort <sup>™</sup> connector(s) may be required. See <u>www.amd.com/firepro</u> for details.
NVIDIA Quadro 410 512MB Graphics	Form Factor	Low Profile: 2.713 inches × 5.7 inches, single slot
	Graphics Controller	NVIDIA Quadro 410



	Bus Type	PCI Express x16, 3.0 compliant
	Memory	Size: 512MB DDR3
	remory	Clock: 900MHz
		Memory Bandwidth: 14GB/s
	Connectors	One dual-link DVI-I connector
	Maarian	One DisplayPort connector
	Maximum Resolution	Up to 2560 x 1600 (digital display) per display.
	RAMDAC	400 MHz integrated RAMDAC
	Display Output	Maximum resolution over DisplayPort: 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)
		Maximum resolution over DVI port: 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)
		Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 × 32 bpp at 85 Hz
	Shading Architecture	Shader Model 5.0
	Supported Graphics APIs	DX11, OpenGL 4.2
	Available Graphics Drivers	Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL)
		SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)
		HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:
		http://welcome.hp.com/country/us/en/support.html
		SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or <u>http://www.nvidia.com</u>
NVIDIA Quadro K600 1GB Graphics	Form Factor	2.731" H x 6.3" L Single Slot, Low Profile Full Height Profile bracket installed Low Profile bracket included
	Graphics Controller	NVIDIA Quadro K600 Graphics Card Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts
	Bus Type	PCI Express 2.0 x16
	Memory	1 GB GDDR3, 891 Mhz 128-bit memory I/O path 29 GB/s memory bandwidth
	Connectors	1 DL-DVI(I) output, 1 DisplayPort output CTO: No video cable adapter included AMO: One DP-to-DVI adapter included with card
		Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as accessories
	Maximum Resolution	DisplayPort: - up to 3840 x 2160 x 30 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)



#### **Technical Specifications - Graphics**

Image Quality Features Display Output	DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60Hz 10-bit internal display processing pipeline 10-bit scan-out support VGA: - requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters - 400 Mhz integrated RAMDAC - Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz
	DL-DVI(I): - Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz
	SL-DVI(I): - Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz
	DisplayPort: - Supports HBR2 and MST - Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to the Quadro K600 DisplayPort connector at this resolution) - Max number of daisy-chained monitors: 2
Shading Architecture	Full Microsoft DirectX 11 Shader Model 5.0
Supported Graphics APIs	OpenGL 4.3 DirectX 11 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
Available Graphics Drivers	Windows 8 Pro 64-bit Windows 8 (China) 64-bit Genuine Windows 7 Professional (64-bit and 32-bit)
	Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit)
	HP qualified drivers may be preloaded or available from the HP support Web site: <u>http://welcome.hp.com/country/us/en/support.html</u>
Notes	<ul> <li>SUSE Linux Enterprise drivers may also be obtained from: <u>ftp://download.nvidia.com/novell</u> or <u>http://www.nvidia.com</u></li> <li>1. Quadro K600 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.</li> <li>2. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additonal cables must be ordered separately.</li> <li>3. Quadro K600 is Windows 8 Compliant.</li> <li>4. A total maximum of 2 active monitors are supported across all display output types.</li> </ul>



#### Technical Specifications - Multimedia and Audio Devices

 HP Thin USB Powered
 Frequency Response
 F0 to 20kHz

 Speakers
 (-3dB, 24-bit/96kHz input)
 F0 to 20kHz

 Dimensions (H x W x D)
 Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker

HP DVD-ROM Drive	Description	5.25-inch, half-height, tray-load		
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)		
	Dimensions (WxHxD)			
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB	
	Access Times	DVD-ROM Single Layer	< 140 ms (typical)	
		CD-ROM Mode 1	< 125 ms (typical)	
		Full Stroke DVD	< 250 ms (seek)	
		Full Stroke CD	< 210 ms (seek)	
	Power	Source	SATA DC power receptacle	
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC - < 600 mA typical, < 1400 mA maximum	
	<b>Operating Environmental</b>	Temperature	41° to 122° F (5° to 50° C)	
	(all conditions non-	<b>Relative Humidity</b>	10% to 90%	
	condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
		Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.	
HP DVD+/-RW Drive	Description	5.25-inch, half-height, tra		
	Mounting Orientation	Either horizontal or vertic	al	
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x	x 1.7 x 8.0 in)	
	Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL		

8.5 GB DL or 4.7 GB standard

< 250 ms (seek) < 210 ms (seek)

DVD-R DVD-RW CD-R CD-RW

DVD-ROM

**Full Stroke DVD** 

**Full Stroke CD** 

**Disc Capacity** 

-	-	-		
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40 CD-RW Up to 32X	хс	
		DVD ROM Read	DVD-RAM	Up to 12X
			DVD+RW	Up to 8X
			DVD-RW	Up to 8X
			DVD+R DL	Up to 8X
			DVD-R DL	Up to 8X
			DVD-ROM	Up to 16X
			DVD-ROM DL	Up to 8X
			DVD+R	Up to 16X
			DVD-R	Up to 16X
	Power	Source	SATA DC power recepta	acle
		DC Power Requirements	5 VDC ± 5%-100 mV riț 12 VDC ± 5%-200 mV r	
		DC Current	5 VDC -1000 mA typica 12 VDC -600 mA typica	
	Operating Environmental	Temperature	41° to 122° F (5° to 50°	° C)
	(all conditions non-	Relative Humidity	10% to 90%	
condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
		Operating Systems Supported	Windows 7 Professiona Windows Vista Business Business 32*, Windows Windows 2000, Window Windows XP Home 32* Red Hat Enterprise Line Desktop/Workstation SUSE Linux Enterprise	ss 64*, Windows Vista s Vista Home Basic 32*, ws XP Professional or ux(RHEL) WS4**, 5, 6
			No driver is required fo support is provided by	
		Kit Contents	HP SATA SuperMulti DV Easy Media Creator sof WinDVD Software, inst DVD+R media.	tware, Intervideo
HP Blu-Ray Writer	Description	5.25-inch, half-height, tra	av-load	
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA		
	Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)		
	Disc Formats	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-R DVD-R		



CD-RW           Disc Capacity         OVD-ROM         8.5 GB DL or 4.7 GB stamJJ           Blu-ray         S0 GB DL or 25 GB stamJJ           Full Stroke DVD         <250 ms (seek)		CD-R		
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Full Stroke CD< 210 ms (seek)		•		diù
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TemperatureOperating SystemsWindows 7 Professional 32-bit and 64-bit,	condensing)	-		
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			Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation, SUSE Linux Enterprise Desktop 10 & 11 * No driver is required for this device. Native support is provided by the operating system. ** RHEL WS4 not supported on Z200/Z200SFF
		Kit Contents	HP Blue Laser RW Drive, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide.
	Disclaimer	digital connection, compa do not constitute defects is not guaranteed. In orde a DVI or HDMI digital conn	It containing new technologies, certain disc, tibility and/or performance issues may arise, and in the product. Flawless playback on all systems r for some Blu-Ray titles to play, they may require ection and your display may require HDCP cannot be played on this workstation.
HP 15-in-1 Media Card Reader	Description	Supports hardware CRC (C Supports MS 4-bit paralle Supports MS-PRO 4-bit pa Supports MS PRO-HG Duo Supports SD 4-bit paralle Supports UHS-104 SD 4-b	arallel transfer mode 9 4-bit parallel transfer mode 1 transfer mode
	Interface Type	USB 3.0 High-speed interf Note: If there is a USB2 co	face nnection, USB2 transfer speeds are supported.
	Dimensions (WxHxD)	4.9 x 4 x 1 in (124.5 x 101 bay.	.6 x 25.4 mm) Fits conveniently in the 5.25" drive
	Supported Media Types	CompactFlash Type I CompactFlash Type II Microdrive Secure Digital Card (SD) Secure Digital High Capaci SD Extended Capacity Mer SD Ultra High Speed II(SD Memory Stick Memory Stick Select Memory Stick PRO (MS Du Memory Stick PRO (MS PR Memory Stick PRO Duo (M Memory Stick PRO Duo (M Memory Stick PRO-HG Du MagicGate Memory Stick I	o) UHSII) O) IS PRO Duo) o (MG) Duo
		These additional media ty Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (M	vpes are supported with a card adapter. icroSD)



	Micro SD High Capacity Memory Card (MicroSDHC)
	Test Parameters/Conditions - Power applied, unit operating on system ±5%
Operating Systems Supported	Windows 8 Pro (64-bit)* Windows 8.1 (64-bit)* Windows 8 (64-bit)* Windows 7 Ultimate (32-bit)** Windows 7 Ultimate (64-bit)** Windows 7 Professional (32-bit)** Windows 7 Professional (64-bit)** Windows 7 Home Basic** Windows 7 Home Premium (32-bit)** Windows 7 Home Premium (64-bit)** Windows Vista Business 64 Windows Vista Business 32 Windows Vista Home Basic 32 Windows XP Professional Windows XP Home 32 No driver is required for this device. Native support is provided by the operating system.
	Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See <u>http://www.microsoft.com</u> . Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See <u>http://www.microsoft.com/windows/windows-7/</u> for details.
Kit Contents	Media card reader, 5.25" bracket/rails/bezel, Install Guide, IO & Security Software and Documentation CD
Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT
Weight	0.35 lbs (0.16 kg)



### Technical Specifications - Controller Cards

HP IEEE 1394b FireWire	Data Transfer Rate	Supports up to 800 Mbps
PCIe Card	<b>Devices Supported</b>	IEEE-1394 compliant devices
	Bus Type	PCIe card full height PCIe slots
	Ports	Two IEEE-1394b bilingual 9-Pin Connector (Rear)
	Internal Connectors	One 10-Pin header Custom Connector
	System Requirements	Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD- ROM drive, built in sound system, Available PCIe slot.
	Temperature – Operating	50° to 131° F (10° to 55° C)
	Temperature – Storage	–22° to 140° F (–30° to 60° C)
	Relative Humidity – Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and SLED 11.
	Data Transfer Rate	Supports up to 20 Gb/s (20,000 Mb/s)
	Devices Supported	Thunderbolt™ certified devices
	Bus Type	PCIe card, full or half height PCIe slots
	Ports	One Thunderbolt™ 2 external 20-Pin output connectors (Rear)
	Internal Connectors	One 5-Pin header connector
	System Requirements	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel i5 series or higher processor, 128-MB RAM, 1-GB Hard Drive, available PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.
	Kit Contents	HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height bracket, DisplayPort to DisplayPort cable, internal header cables (2), user documentation and warranty card.
	Warranty	The HP Thunderbolt <sup>™</sup> 2 PCIe 1-port I/O Card has a one-year Limited Warranty or the remainder of the warranty of the HP supported product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions and exclusions apply.



#### Summary of Changes

Date of change:	Version History:		Description of change:
June 1, 2014	From v15 to v16	Added	ldNumber
September 4. 2014	From v16 to v17	Changed	Added HP Client Security and the Intel Core i3-4160, OS section updated.
November 1, 2014	From v17 to v18	Added	HP 15-in-1 Media Card Reader
		Removed	Intel® Xeon® processor E3-1270v3, Intel® Xeon® processor E3- 1230v3, Intel® Core™ i3-4330, Intel® Pentium® G3220, NVIDIA Quadro 410 512MB Graphics, Genuine Windows® 7 Ultimate 64-bit, Genuine Windows® 7 Home Premium 32/64-bit, HP 14-in-1 Media Card Reader
December 1, 2014	From v18 to v19	Added	Ubuntu Desktop Linux 14.04, NVIDIA Quadro K620
		Changed	OS, entry 3D and processors section
		Removed	Windows 7 Ultimate 64-bit,Intel Pentium <sup>®</sup> G3220 processor 3.00 3 MB 1333 MHz 2 N N HDGraphics, Intel Core™ i3-4330 processor 3.50 4 MB 1600 MHz 2 Y N 4600, Intel Xeon processor E3-1230v3 3.30 3.70 8 MB 1600 MHz 4 Y Y No, Intel Xeon processor E3-1270v3 3.50 3.90 8 MB 1600 MHz 4 Y Y No
January 1, 2014	From v19 to v20	Removed	Core i7, i5 and Intel Pentium Processors, 250, 500 and 1TB SATA 10k rpm HDDs
February 1, 2015	From v19 to v20	Added	OS, Windows 8.1 64-bit

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